

5 é / Descriptions

BRCL4070SE 2.8V 1.2A P-MOSFET 4.2V 1/10k

BRCL4070SE 2.8V 1.2A P-MOSFET 4.2V 1/10k

BRCL4070SE 2.8V 1.2A P-MOSFET 4.2V 1/10k

BRCL4070SE 2.8V 1.2A P-MOSFET 4.2V 1/10k

µC / Features

- < 6.8V OVP
- < VDD 36V
- < 9f9
- < 40V P-
- < 1.2A
- < 9 <" -
- < 1/2 -
- < Ç-
- < 2.8V@v ä Ef9
- < 6 P ß -
- < J ESOP-8/x
- < ...`RoHS ö Ö k —)í D }ož

€ Đ / Applications

- < ;9 ( )
- < ý¹
- < R Ĩ ö Ñ
- < %- P Ž ` " — Ö

€ Đ Ö · / Application Circuit

Ö hy )P < 93 \* [ , k 8 P < 93 \* Š 8ož

PIN Num.	Symbol	Function
1	TEMP	Temperature sensor
2	685 -	685 ohm resistor
3	GND	Ground
4	VDD	VDD supply

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Power Supply						
Input Supply Voltage	$V_{DD}$		4.5	5.0	6.0	V
$V_{DD}$ Under Voltage Lockout Threshold	V					

Ô4î x ? d / Electrical Characteristics(Ta=25 )

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Indicator Pin Status CHRG/STDBY						
CHRG Pin Output Current	I <sub>CHRG</sub>	V <sub>DD</sub> =5V;V <sub>CHRG</sub> =1V	1	2.5	5	mA
STDBY Pin Output Current	I <sub>STDBY</sub>	V <sub>DD</sub> =5V;V <sub>STDBY</sub> =1V	1	2.5	5	mA
Internal Temperature Compensation						
Internal Temperature Compensation	T <sub>OTC</sub>			140		-
Overtemperature Detection Threshold	T <sub>OTPH</sub>	: + 3 6 N 4 : )	Š	43%* V <sub>DD</sub>	45%* V <sub>DD</sub>	V
Low Temperature Detection Threshold	T <sub>OTPL</sub>	: + 3 6 N 4 : )	Š	80%* V <sub>DD</sub>	82%* V <sub>DD</sub>	V

< Â ä ¢ / Principle block diagram

BRCL4070SE-4.2

Rev.B Mar.-2026

◁ •xt0

ò ç / Ì " † j £ ³ 140 - Ä — › Y k BRCL4070SE Ä B ½ F Ø ê è 1 x 4 — -  
vož ¥ U ... 2 / Ì ½ ož ' š ŷ μ 9 " ` ò 8 Ä k U ŷ G Á ° ê Ë " † Û — - vož

◁ >š 8 J 6

Ø □ = ) ϕ / Package Dimensions

, M y f / Marking Instructions

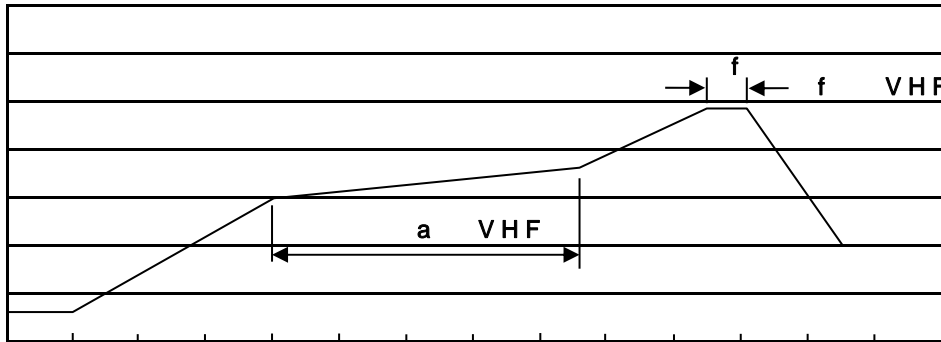
BR  
4070-XX  
\*\*\*\*

° Z y  
( 8 y            , [ W A  
          y            ° Z W A  
>> y            W n ÿ ß 9 k ò n ñ P  
          y            ÿ D Z W A k š ÿ D Z J

° Z	- ~
BRCL4070SE-4.2	BR/4070-42/****

šWD t...•Žϕ (x/ ) / :KSVKXGZ[XK 6XULORK LUX /8 8KLRU] 9URJKXOTM 6

7HPSHUDWXUH



7LPH VHF

a ϕ y

1o• Ä ½ “ † 150 ½180 - k ž • 60 ½90sec;

2o• Q › “ † 245 r5 - k ž • 4 Ò 5 r0.5sec;

3o•D N ò i Ò 0 , † 2 ½10 - /sec.

Note:

1.Preheating:150~180 - , Time:60~90sec.

2.Peak Temp.:245 r5 - , Duration:5 r0.5sec.

3. Cooling Speed: 2~10 - /sec.

ÄD /Cã p ~ » ] / Resistance to Soldering Heat Test Conditions

“ † y 260 r5 -

ž • y 10 r1 sec.

Temp.:260±5

Time:10±1 sec

G P á / Packaging SPEC.

2 & x / REEL

Package Type 7>û ~ E	Units ;>û !H					Dimension ;>û p . (unit /Æmm³)		
	Units/Reel /--	Reels/Inner Box -- /-	Units/Inner Box /-	Inner Boxes/Outer Box - /!ç	Units/Outer Box /!ç	Reel	Inner Box	Outer Boxç
SOP/ESOP-8	4,000	2	8,000	6	48,000	13 s x12	360x360x50	380x335x366

„Đ y f / Notices

Î † U ^ ñ Ä ' Î @ ! c ^ 2 Á Ò ç ³ Ø ož

All information provided in this document is subject to legal disclaimers.